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Application Number

Filing Date

October 31, 2000

First Named Inventor

David Hoyle

Examiner Name

Group / Art Unit

Attorney Docket No.

TI-30554

TOTAL AMOUNT OF PAYMENT

(\$ 710.00)

METHOD OF PAYMENT

- 1.
- ☒
- The Commissioner is hereby authorized to charge to the following Deposit Account,

Deposit Account Number

20-0668

Deposit Account Name

Texas Instruments Incorporated

- ☒
- Charge any additional fee required or credit any overpayment
- ☐
- Charge all indicated fees and any additional fee required or credit any overpayment

- 2.
- ☐
- Payment Enclosed:

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Other

FEE CALCULATION**1. BASIC FILING FEE**

Large Fee Code	Entity Fee (\$)	Small Fee Code	Entity Fee (\$)	Fee Description	Fee Paid
101	710	201	395	Utility filing fee	\$710
106	310	206	165	Design filing fee	\$
107	480	207	270	Plant filing fee	\$
108	760	208	395	Reissue filing fee	\$
114	150	214	75	Provisional filing fee	\$

SUBTOTAL (1)

(\$710)

2. EXTRA CLAIM FEES

Total Claims	Extra Claims	Fee from below	Fee Paid
11	-20** = 0	18	0
Independent Claims	3	-3** = 0	80
Multiple Dependent		260	

**or number previously paid, if greater, For Reissue, see below

Large Fee Code	Entity Fee (\$)	Small Fee Code	Entity Fee (\$)	Fee Description
103	18	203	11	Claims in excess of 20
102	78	202	41	Independent Claims in excess of 3
104	260	204	135	Multiple dependent claims in excess of 3
109	78	209	41	**Reissue independent claims over original patent
110	18	210	11	**Reissue claims in excess of 20 and over original patent

SUBTOTAL (2)

(\$ 0)

FEE CALCULATION (continued)**3. ADDITIONAL FEES**

Large Fee Code	Entity Fee (\$)	Small Fee Code	Entity Fee (\$)	Fee Description	Fee Paid
105	130	205	65	Surcharge - late filing fee	
127	50	227	25	Surcharge - late provisional filing fee or cover sheet.	
139	130	139	130	Non-English specification	
147	2,520	147	2,520	For filing a request for reexamination	
112	920*	112	920*	Requesting publication of SIR prior to Examiner action	
113	1,840*	113	1,840*	Requesting publication of SIR after Examiner action	
115	110	215	55	Extension for reply within first month	
116	380	216	200	Extension of time within second month	
117	870	217	475	Extension of time within third month	
118	1,360	218	755	Extension of time within fourth month	
128	1,850	228	1,030	Extension of time within fifth month	
119	300	219	155	Notice of Appeal	
120	300	220	155	Filing a brief in support of an appeal	
121	260	221	135	Request for oral hearing	
138	1,510	138	1,510	Petition to institute a public use proceeding	
140	110	240	55	Petition to revive - unavoidable	
141	1,210	241	660	Petition to revive - unintentional	
142	1,210	242	660	Utility issue fee (or reissue)	
143	430	243	225	Design issue fee	
144	580	244	335	Plant issue fee	
122	130	122	130	Petitions to the Commissioner	
123	50	123	50	Petitions related to provisional applications	
126	240	126	240	Submission of Information Disclosure Stmt.	
581	40	581	40	Recording each patent assignment per properly (time number of properties)	
146	760	246	395	Filing a submission after final rejection (37 CFR 1.129(a))	
149	760	249	395	For each additional invention to be examined (37 CFR 1.129(b))	

Other fee (specify)

Other fee (specify)

*Reduced by Basic Filing Fee Paid

SUBTOTAL (3)

SUBMITTED BY

Typed or Printed Name

Gerald E. Laws

Signature

Date

October 31, 2000

Complete (if applicable)

Reg Number

39,268

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MICROPROCESSOR WITH ROUNDING MULTIPLY INSTRUCTIONS

5

David Hoyle

10 This application claims priority under 35 USC §119(e)(1) of Provisional
Application No. 60/183,527, filed February 18, 2000 (TI-30302PS) and of
Provisional Application No. 60/183,654, filed February 18, 2000 (TI-26010PS)

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20 copyright rights whatsoever.

Technical Field of the Invention

25 This invention relates to data processing devices, electronic processing
and control systems and methods of their manufacture and operation, and
particularly relates to microprocessors optimized for digital signal processing.

Background of the Invention

Generally, a microprocessor is a circuit that combines the instruction-handling, arithmetic, and logical operations of a computer on a single semiconductor integrated circuit. Microprocessors can be grouped into two general classes, namely general-purpose microprocessors and special-purpose microprocessors. General-purpose microprocessors are designed to be programmable by the user to perform any of a wide range of tasks, and are therefore often used as the central processing unit (CPU) in equipment such as personal computers. Special-purpose microprocessors, in contrast, are designed to provide performance improvement for specific predetermined arithmetic and logical functions for which the user intends to use the microprocessor. By knowing the primary function of the microprocessor, the designer can structure the microprocessor architecture in such a manner that the performance of the specific function by the special-purpose microprocessor greatly exceeds the performance of the same function by a general-purpose microprocessor regardless of the program implemented by the user.

One such function that can be performed by a special-purpose microprocessor at a greatly improved rate is digital signal processing. Digital signal processing generally involves the representation, transmission, and manipulation of signals, using numerical techniques and a type of special-purpose microprocessor known as a digital signal processor (DSP). Digital signal processing typically requires the manipulation of large volumes of data, and a digital signal processor is optimized to efficiently perform the intensive computation and memory access operations associated with this data manipulation. For example, computations for performing Fast Fourier Transforms (FFTs) and for implementing digital filters consist to a large degree of repetitive operations such as multiply-and-add and multiple-bit-shift. DSPs can be specifically adapted for these repetitive functions, and

provide a substantial performance improvement over general-purpose microprocessors in, for example, real-time applications such as image and speech processing.

DSPs are central to the operation of many of today's electronic products, such as high-speed modems, high-density disk drives, digital cellular phones, complex automotive systems, and video-conferencing equipment. DSPs will enable a wide variety of other digital systems in the future, such as video-phones, network processing, natural speech interfaces, and ultra-high speed modems. The demands placed upon DSPs in these and other applications continue to grow as consumers seek increased performance from their digital products, and as the convergence of the communications, computer and consumer industries creates completely new digital products.

Microprocessor designers have increasingly endeavored to exploit parallelism to improve performance. One parallel architecture that has found application in some modern microprocessors utilizes multiple instruction fetch packets and multiple instruction execution packets with multiple functional units.

Digital systems designed on a single integrated circuit are referred to as an application specific integrated circuit (ASIC). MegaModules are being used in the design of ASICs to create complex digital systems a single chip. (MegaModule is a trademark of Texas Instruments Incorporated.) Types of MegaModules include SRAMs, FIFOs, register files, RAMs, ROMs, universal asynchronous receiver-transmitters (UARTs), programmable logic arrays and other such logic circuits. MegaModules are usually defined as integrated circuit modules of at least 500 gates in complexity and having a complex ASIC macro function. These MegaModules are predesigned and stored in an ASIC design library. The MegaModules can then be selected by a designer and placed within a certain area on a new IC chip.

Designers have succeeded in increasing the performance of DSPs, and microprocessors in general, by increasing clock speeds, by removing data processing bottlenecks in circuit architecture, by incorporating multiple execution units on a single processor circuit, and by developing optimizing compilers that schedule operations to be executed by the processor in an efficient manner. The increasing demands of technology and the marketplace make desirable even further structural and process improvements in processing devices, application systems and methods of operation and manufacture.

Summary of the Invention

An illustrative embodiment of the present invention seeks to provide a microprocessor, and a method for operating a microprocessor that improves digital signal processing performance. Aspects of the invention are specified in the claims.

In an embodiment of the present invention, a digital signal processor is provided which has an instruction for forming a 16 x 32-bit product that is rounded and then truncated to form a 32-bit result.

In an embodiment of the invention, a 32-bit operand is treated as two 16-bit fields. In another embodiment, an operand size different from 32-bits may be operated on, and the field sizes may be different than 16 bits.

In an embodiment of the invention, one instruction is provided which selects a high half word from two packed fields, and another instruction is provided that selects a low half word from two packed fields. In another embodiment, the number of fields may be different than two. In another embodiment, a control register or parameter selects the field.

Brief Description of the Drawings

Other features and advantages of the present invention will become apparent by reference to the following detailed description when considered in conjunction with the accompanying drawings, in which:

Figure 1 is a block diagram of a digital signal processor (DSP), showing components thereof pertinent to an embodiment of the present invention;

Figure 2 is a block diagram of the functional units, data paths and register files of Figure 1;

Figures 3A-3J show an opcode map for the DSP of Figure 1;

Figure 4 is a timing diagram illustrating instruction execution pipeline phase of the processor of Figure 1;

Figure 5 illustrates an instruction syntax for a Multiply 16 lsb X 32-bit, shift and round (MPYLIR) instruction and a Multiply 16 msb X 32-bit, shift and round (MPYHIR) instruction;

Figure 6A is a flow chart illustrating operation of the MPYHIR instruction;

Figure 6B is a flow chart illustrating operation of the MPYLIR instruction;

Figure 6C is a flow chart illustrating an alternative embodiment of the operation of the MPYLIR instruction;

Figure 7A is a block diagram illustrating a multiply circuit for performing MPY(H/L)IR instructions within an .M functional unit;

Figure 7B is a block diagram of a pair of multipliers in an M unit of the DSP of Figure 1; and

Figure 8 illustrates an exemplary implementation of a digital system that includes an embodiment of the present invention in a mobile telecommunications device.

Detailed Description of Embodiments of the Invention

Figure 1 is a block diagram of a microprocessor 1 which has an embodiment of the present invention. Microprocessor 1 is a VLIW digital signal processor ("DSP"). In the interest of clarity, Figure 1 only shows those portions of microprocessor 1 that are relevant to an understanding of an embodiment of the present invention. Details of general construction for DSPs are well known, and may be found readily elsewhere. For example, U.S. Patent 5,072,418 issued to Frederick Boutaud, et al, describes a DSP in detail and is incorporated herein by reference. U.S. Patent 5,329,471 issued to Gary Swoboda, et al, describes in detail how to test and emulate a DSP and is incorporated herein by reference. Details of portions of microprocessor 1 relevant to an embodiment of the present invention are explained in sufficient detail hereinbelow, so as to enable one of ordinary skill in the microprocessor art to make and use the invention.

In microprocessor 1 there are shown a central processing unit (CPU) 10, data memory 22, program memory 23, peripherals 60 and an external memory interface (EMIF) with a direct memory access (DMA) 61. CPU 10 further has an instruction fetch/decode unit 10a-c, a plurality of execution units, including an arithmetic and load/store unit D1, a multiplier M1, an ALU/shifter unit S1, an arithmetic logic unit ("ALU") L1, a shared multi-port register file 20a from which data are read and to which data are written. Instructions are fetched by fetch unit 10a from instruction memory 23 over a set of busses 41. Decoded instructions are provided from the instruction fetch/decode unit 10a-c to the functional units D1, M1, S1, and L1 over various sets of control lines which are not shown. Data are provided to/from the register file 20a from/to to load/store units D1 over a first set of busses 32a, to multiplier M1 over a second set of busses 34a, to ALU/shifter unit S1 over a third set of busses 36a and to ALU L1 over a fourth set of busses 38a. Data are provided to/from the memory 22 from/to the load/store units D1 via

a fifth set of busses 40a. Note that the entire data path described above is duplicated with register file 20b and execution units D2, M2, S2, and L2. In this embodiment of the present invention, two unrelated aligned double word (64 bits) load/store transfers can be made in parallel between CPU 10 and data memory 22 on each clock cycle using bus set 40a and bus set 40b.

A single non-aligned double word load/store transfer is performed by scheduling a first .D unit resource and two load/store ports on memory 22. Advantageously, an extraction circuit is connected to the memory subsystem to provide a non-aligned data item extracted from two aligned data items requested by the .D unit. Advantageously, a second .D unit can perform 32-bit logical or arithmetic instructions in addition to the .S and .L units while the address port of the second .D unit is being used to transmit one of two contiguous addresses provided by the first .D unit. Furthermore, a non-aligned access near the end of a circular buffer region in the target memory provides a non-aligned data item that wraps around to the other end of the circular buffer.

Emulation circuitry 50 provides access to the internal operation of integrated circuit 1 that can be controlled by an external test/development system (XDS) 51. External test system 51 is representative of a variety of known test systems for debugging and emulating integrated circuits. One such system is described in U.S. Patent 5,535,331, which is incorporated herein by reference. Test circuitry 52 contains control registers and parallel signature analysis circuitry for testing integrated circuit 1.

Note that the memory 22 and memory 23 are shown in Figure 1 to be a part of a microprocessor 1 integrated circuit, the extent of which is represented by the box 42. The memories 22-23 could just as well be external to the microprocessor 1 integrated circuit 42, or part of it could reside on the integrated circuit 42 and part of it be external to the integrated circuit 42. These are matters of design choice. Also, the particular selection and number

of execution units are a matter of design choice, and are not critical to the invention.

When microprocessor 1 is incorporated in a data processing system, additional memory or peripherals may be connected to microprocessor 1, as illustrated in Figure 1. For example, Random Access Memory (RAM) 70, a Read Only Memory (ROM) 71 and a Disk 72 are shown connected via an external bus 73. Bus 73 is connected to the External Memory Interface (EMIF) which is part of functional block 61 within microprocessor 1. A Direct Memory Access (DMA) controller is also included within block 61. The DMA controller is generally used to move data between memory and peripherals within microprocessor 1 and memory and peripherals which are external to microprocessor 1.

In the present embodiment, CPU core 10 is encapsulated as a MegaModule, however, other embodiments of the present invention may be in custom designed CPU's or mass market microprocessors, for example.

A detailed description of various architectural features of the microprocessor of Figure 1 is provided in coassigned application S.N. 09/012,813 (TI-25311) and is incorporated herein by reference. A description of enhanced architectural features and an extended instruction set not described herein for CPU 10 is provided in coassigned U.S. Patent application S.N. _____ (TI-30302) *Microprocessor with Improved Instruction Set Architecture* and is incorporated herein by reference.

Figure 2 is a block diagram of the execution units and register files of the microprocessor of Figure 1 and shows a more detailed view of the buses connecting the various functional blocks. In this figure, all data busses are 32 bits wide, unless otherwise noted. There are two general-purpose register files (A and B) in the processor's data paths. Each of these files contains 32 32-bit registers (A0-A31 for file A and B0-B31 for file B). The general-purpose registers can be used for data, data address pointers, or condition

registers. Any number of reads of a given register can be performed in a given cycle.

The general-purpose register files support data ranging in size from packed 8-bit data through 64-bit fixed-point data. Values larger than 32 bits, such as 40-bit long and 64-bit double word quantities, are stored in register pairs, with the 32 LSBs of data placed in an even-numbered register and the remaining 8 or 32 MSBs in the next upper register (which is always an odd-numbered register). Packed data types store either four 8-bit values or two 16-bit values in a single 32-bit register.

There are 32 valid register pairs for 40-bit and 64-bit data, as shown in Table 1. In assembly language syntax, a colon between the register names denotes the register pairs and the odd numbered register is encoded in the instruction opcode.

Table 1 - 40-Bit/64-Bit Register Pairs

Register Files	
A	B
A1:A0	B1:B0
A3:A2	B3:B2
A5:A4	B5:B4
A7:A6	B7:B6
A9:A8	B9:B8
A11:A10	B11:B10
A13:A12	B13:B12
A15:A14	B15:B14
A17:A16	B17:B16
A19:A18	B19:B18
A21:A20	B21:B20
A23:A22	B23:B22
A25:A24	B25:B24
A27:A26	B27:B26
A29:A28	B29:B28
A31:A30	B31:B30

For 40-bit data, operations requiring a long input ignore the 24 MSBs of the odd register. Operations producing a long result zero-fill the 24 MSBs of the odd register. The even register is encoded in the opcode.

5 The eight functional units in processor 10's data paths are be divided into two groups of four; each functional unit in one data path is almost identical to the corresponding unit in the other data path. The functional units are described in Table 2.

10 Besides being able to perform 32-bit data manipulations, processor 10 also contains many 8-bit and 16-bit data instructions in the instruction set. For example, the MPYU4 instruction performs four 8x8 unsigned multiplies with a single instruction on a .M unit. The ADD4 instruction performs four 8-bit additions with a single instruction on a .L unit.

Table 2 Functional Units and Operations Performed

Functional Unit	Fixed-Point Operations
.L unit (.L1, .L2)	32/40-bit arithmetic and compare operations 32-bit logical operations Leftmost 1 or 0 counting for 32 bits Normalization count for 32 and 40 bits Byte shifts Data packing/unpacking 5-bit constant generation Paired 16-bit arithmetic operations Quad 8-bit arithmetic operations Paired 16-bit min/max operations Quad 8-bit min/max operations
.S unit (.S1, .S2)	32-bit arithmetic operations 32/40-bit shifts and 32-bit bit-field operations 32-bit logical operations Branches Constant generation Register transfers to/from control register file (.S2 only) Byte shifts Data packing/unpacking Paired 16-bit compare operations Quad 8-bit compare operations Paired 16-bit shift operations Paired 16-bit saturated arithmetic operations Quad 8-bit saturated arithmetic operations
.M unit (.M1, .M2)	16 x 16 multiply operations 16 x 32 multiply operations Bit expansion Bit interleaving/de-interleaving Quad 8 x 8 multiply operations Paired 16 x 16 multiply operations Paired 16 x 16 multiply with add/subtract operations Quad 8 x 8 multiply with add operations Variable shift operations Rotation Galois Field Multiply
.D unit (.D1, .D2)	32-bit add, subtract, linear and circular address calculation Loads and stores with 5-bit constant offset Loads and stores with 15-bit constant offset (.D2 only) Load and store double words with 5-bit constant Load and store non-aligned words and double words 5-bit constant generation 32-bit logical operations

Most data lines in the CPU support 32-bit operands, and some support long (40-bit) and double word (64-bit) operands. Each functional unit has its own 32-bit write port into a general-purpose register file (Refer to Figure 2). All units ending in 1 (for example, .L1) write to register file A 20a and all

units ending in 2 write to register file B 20b. Each functional unit has two 32-bit read ports for source operands *src1* and *src2*. Four units (.L1, .L2, .S1, and .S2) have an extra 8-bit-wide port for 40-bit long writes, as well as an 8-bit input for 40-bit long reads. Because each unit has its own 32-bit write port,
 5 when performing 32 bit operations all eight units can be used in parallel every cycle. Since each multiplier can return up to a 64-bit result, two write ports are provided from the multipliers to the register file.

Register File Cross Paths

Each functional unit reads directly from and writes directly to the register file within its own data path. That is, the .L1, .S1, .D1, and .M1 units write to register file A and the .L2, .S2, .D2, and .M2 units write to register file B. The register files are connected to the opposite-side register file's functional units via the 1X and 2X cross paths. These cross paths allow
 15 functional units from one data path to access a 32-bit operand from the opposite side's register file. The 1X cross path allows data path A's functional units to read their source from register file B. Similarly, the 2X cross path allows data path B's functional units to read their source from register file A.

All eight of the functional units have access to the opposite side's register file via a cross path. The .M1, .M2, .S1, .S2, .D1 and .D2 units' *src2* inputs are selectable between the cross path and the same side register file. In the case of the .L1 and .L2 both *src1* and *src2* inputs are also selectable between the cross path and the same-side register file.

Only two cross paths, 1X and 2X, exist in this embodiment of the architecture. Thus the limit is one source read from each data path's opposite register file per cycle, or a total of two cross-path source reads per cycle. Advantageously, multiple units on a side may read the same cross-path source simultaneously. Thus the cross path operand for one side may be used
 25 by any one, multiple or all the functional units on that side in an execute

packet. In the C62x/C67x, only one functional unit per data path, per execute packet could get an operand from the opposite register file.

A delay clock cycle is introduced whenever an instruction attempts to read a register via a cross path that was updated in the previous cycle. This is known as a cross path stall. This stall is inserted automatically by the hardware; no NOP instruction is needed. It should be noted that no stall is introduced if the register being read is the destination for data loaded by a LDx instruction.

Memory, Load and Store Paths

Processor 10 supports double word loads and stores. There are four 32-bit paths for loading data for memory to the register file. For side A, LD1a is the load path for the 32 LSBs; LD1b is the load path for the 32 MSBs. For side B, LD2a is the load path for the 32 LSBs; LD2b is the load path for the 32 MSBs. There are also four 32-bit paths, for storing register values to memory from each register file. ST1a is the write path for the 32 LSBs on side A; ST1b is the write path for the 32 MSBs for side A. For side B, ST2a is the write path for the 32 LSBs; ST2b is the write path for the 32 MSBs.

Some of the ports for long and double word operands are shared between functional units. This places a constraint on which long or double word operations can be scheduled on a datapath in the same execute packet.

Data Address Paths

Bus 40a has an address bus DA1 which is driven by mux 200a. This allows an address generated by either load/store unit D1 or D2 to provide a memory address for loads or stores for register file 20a. Data Bus LD1 loads data from an address in memory 22 specified by address bus DA1 to a register in load unit D1. Unit D1 may manipulate the data provided prior to storing it in register file 20a. Likewise, data bus ST1 stores data from

register file 20a to memory 22. Load/store unit D1 performs the following operations: 32-bit add, subtract, linear and circular address calculations. Load/store unit D2 operates similarly to unit D1, with the assistance of mux 200b for selecting an address.

5 The DA1 and DA2 resources and their associated data paths are specified as T1 and T2 respectively. T1 consists of the DA1 address path and the LD1a, LD1b, ST1a and ST1b data paths. Similarly, T2 consists of the DA2 address path and the LD2a, LD2b, ST2a and ST2b data paths. The T1 and T2 designations appear in functional unit fields for load and store
10 instructions.

For example, the following load instruction uses the .D1 unit to generate the address but is using the LD2a path resource from DA2 to place the data in the B register file. The use of the DA2 resource is indicated with the T2 designation, for example: LDW .D1T2 *A0[3], B1.

15 Table 3 defines the mapping between instructions and functional units for a set of basic instructions included in a DSP described in U.S. Patent S.N. 09/012,813 (TI-25311, incorporated herein by reference). Table 4 defines a mapping between instructions and functional units for a set of extended instructions in an embodiment of the present invention. Alternative
20 embodiments of the present invention may have different sets of instructions and functional unit mapping. Table 3 and Table 4 are illustrative and are not exhaustive or intended to limit various embodiments of the present invention.

Table 3 Instruction to Functional Unit Mapping of Basic Instructions

.L Unit	.M Unit	.S Unit	.D Unit
ABS	MPY	ADD	ADD
ADD	SMPY	ADDK	ADDA
AND		ADD2	LD mem
CMPEQ		AND	LD mem (15-bit offset) (D2 only)
CMPGT		B disp	MV
CMPGTU		B IRP	NEG
CMPLT		B NRP	ST mem
CMPLTU		B reg	ST mem (15-bit offset) (D2 only)
LMBD		CLR	SUB
MV		EXT	SUBA
NEG		EXTU	ZERO
NORM		MVC	
NOT		MV	
OR		MVK	
SADD		MVKH	
SAT		NEG	
SSUB		NOT	
SUB		OR	
SUBC		SET	
XOR		SHL	
ZERO		SHR	
		SHRU	
		SSHL	
		STP (S2 only)	
		SUB	
		SUB2	
		XOR	
		ZERO	

Table 4 Instruction to Functional Unit Mapping of Extended Instructions

.L unit	.M unit	.S unit	.D unit
ABS2	AVG2	ADD2	ADD2
ADD2	AVGU4	ADDKPC	AND
ADD4	BITC4	AND	ANDN
AND	BITR	ANDN	LDDW
ANDN	DEAL	BDEC	LDNDW
MAX2	DOTP2	BNOP	LDNW
MAXU4	DOTPN2	BPOS	MVK
MIN2	DOTPNRSU2	CMPEQ2	OR
MINU4	DOTPNRUS2 DOTPRSUS2 DOTPRUS2	CMPEQ4 CMPGT2 CMPGTU4	STDW
MVK	DOTPSU4 DOTPUS4	CMPLT2	STNDW
OR	DOTPU4	CMPLTU4	STNW
PACK2	GMPY4	MVK	SUB2
PACKH2	MPY2	OR	XOR
PACKH4	MPYHI	PACK2	
PACKHL2	MPYHIR MPYIH MPYIHR	PACKH2	
PACKL4	MPYIL MPYILR MPYLI	PACKHL2	
PACKLH2	MPYLIR	PACKLH2	
SHLMB	MPYSU4 MPYUS4	SADD2	
SHRMB	MPYU4	SADDU4	
SUB2	MVD	SADDSU2 SADDUS2	
SUB4	ROTL	SHLMB	
SUBABS4	SHFL	SHR2	
SWAP2	SMPY2	SHRMB	
SWAP4	SSHVL	SHRU2	
UNPKHU4	SSHVR	SPACK2	
UNPKLU4	XPND2	SPACKU4	
XOR	XPND4	SUB2	
		SWAP2	
		UNPKHU4	
		UNPKLU4	
		XOR	

The DSP's opcode map is shown in Figures 3A-3J. Refer to the instruction descriptions later herein for explanations of the field syntax and values. An instruction syntax is used to describe each instruction. The opcode map breaks down the various bit fields that make up each instruction. There are certain instructions that can be executed on more than one functional unit, as was shown in Table 4. The syntax specifies the functional unit and various resources used by an instruction, typically as follows:

EXAMPLE (.unit) src, dst

The following are examples of what the syntax looks like for the ADD instruction:

- 5 1) ADD (.unit) *src1*, *src2*, *dst*
 2) ADDU (.unit) *src1*, *src2*, *dst*
 3) ADD (.unit) *src2*, *src1*, *dst*
 unit = .L1, .L2, .S1, .S2, .D1, .D2

10 *src* and *dst* indicate source and destination respectively. The (.unit) dictates which functional unit the instruction is mapped to (.L1, .L2, .S1, .S2, .M1, .M2, .D1, or .D2). This instruction has three opcode map fields: *src1*, *src2*, and *dst*.

15 The addressing modes for instructions that access memory are linear, circular using BK0, and circular using BK1. The mode is specified by an addressing mode register (AMR) contained in control register file 102. Eight registers can perform circular addressing. A4-A7 are used by the .D1 unit and B4-B7 are used by the .D2 unit. No other units can perform circular addressing modes. For each of these registers, the AMR specifies the addressing mode.

20 All instructions can be conditional. The condition is controlled by a 3-bit (*creg*) field specifying a register to be tested, and a 1-bit field (*z*) specifying a test for zero or nonzero, as shown in Figures 3A-3J. The four MSBs of every opcode are *creg* and *z*. The specified register is tested at the beginning of the E1 instruction execution pipeline stage for all instructions. The pipeline is described later herein. If *z* = 1, the test is for equality with zero. If *z* = 0, the
25 test is for nonzero. The case of condition register field (*creg*) = 0 and *z* = 0 is treated as always true to allow instructions to be executed unconditionally. The *creg* register field is encoded as shown in Table 5. Conditional instructions are represented by “[]” surrounding the condition register.

Table 5 Registers That Can Be Tested by Conditional Operations

Creg			z	Register Tested
31	30	29	28	
0	0	0	0	Unconditional.
0	0	0	1	Reserved: When selected this indicates a SWBP instruction
0	0	1	z	B0
0	1	0	z	B1
0	1	1	z	B2
1	0	0	z	
1	0	0	z	A1
1	0	1	z	A2
1	1	x	x	Reserved

Note: x is don't care for reserved cases.

Instructions are always fetched eight at a time. This constitutes a *fetch packet*. The execution grouping of the fetch packet is specified by the *p*-bit, bit zero, of each instruction. Fetch packets are 8-word aligned.

The *p* bit controls the parallel execution of instructions. The *p* bits are scanned from left to right (lower to higher address). If the *p* bit of instruction *i* is 1, then instruction *i* + 1 is to be executed in parallel with (in the same cycle as) instruction *i*. If the *p*-bit of instruction *i* is 0, then instruction *i* + 1 is executed in the cycle after instruction *i*. All instructions executing in parallel constitute an *execute packet*. An execute packet can contain up to eight instructions. All instructions in an execute packet must use a unique functional unit.

Pipeline Operation

The DSP pipeline has several key features which improve performance, decrease cost, and simplify programming. They are: increased pipelining eliminates traditional architectural bottlenecks in program fetch, data access, and multiply operations; control of the pipeline is simplified by eliminating pipeline interlocks; the pipeline can dispatch eight parallel instructions every cycle; parallel instructions proceed simultaneously through the same pipeline phases; sequential instructions proceed with the same relative pipeline phase

difference; and load and store addresses appear on the CPU boundary during the same pipeline phase, eliminating read-after-write memory conflicts.

A multi-stage memory pipeline is present for both data accesses and program fetches. This allows use of high-speed synchronous memories both on-chip and off-chip, and allows infinitely nestable zero-overhead looping with branches in parallel with other instructions.

There are no internal interlocks in the execution cycles of the pipeline, so a new execute packet enters execution every CPU cycle. Therefore, the number of CPU cycles for a particular algorithm with particular input data is fixed. If during program execution, there are no memory stalls, the number of CPU cycles equals the number of clock cycles for a program to execute.

Performance can be inhibited by stalls from the memory system, stalls for cross path dependencies, or interrupts. The reasons for memory stalls are determined by the memory architecture. Cross path stalls are described in detail in U.S. Patent S.N. _____ (TI-30563), to Steiss, et al and is incorporated herein by reference. To fully understand how to optimize a program for speed, the sequence of program fetch, data store, and data load requests the program makes, and how they might stall the CPU should be understood.

The pipeline operation, from a functional point of view, is based on CPU cycles. A CPU cycle is the period during which a particular execute packet is in a particular pipeline stage. CPU cycle boundaries always occur at clock cycle boundaries; however, stalls can cause CPU cycles to extend over multiple clock cycles. To understand the machine state at CPU cycle boundaries, one must be concerned only with the execution phases (E1-E5) of the pipeline. The phases of the pipeline are shown in Figure 4 and described in Table 6.

Table 6 Pipeline Phase Description

Pipeline	Pipeline Phase	Symbol	During This Phase	Instruction Types Completed
Program Fetch	Program Address Generate	PG	Address of the fetch packet is determined.	
	Program Address Send	PS	Address of fetch packet is sent to memory.	
	Program Wait	PW	Program memory access is performed.	
	Program Data Receive	PR	Fetch packet is expected at CPU boundary.	
Program Decode	Dispatch	DP	Next execute packet in fetch packet determined and sent to the appropriate functional units to be decoded.	
	Decode	DC	Instructions are decoded at functional units.	
Execute	Execute 1	E1	For all instruction types, conditions for instructions are evaluated and operands read. Load and store instructions: address generation is computed and address modifications written to register file [†] Branch instructions: affects branch fetch packet in PG phase [†] Single-cycle instructions: results are written to a register file [†]	Single-cycle
	Execute 2	E2	Load instructions: address is sent to memory [†] Store instructions and STP: address and data are sent to memory [†] Single-cycle instructions that saturate results set the SAT bit in the Control Status Register (CSR) if saturation occurs. [†] Multiply instructions: results are written to a register file [†]	Stores STP Multiplies
	Execute 3	E3	Data memory accesses are performed. Any multiply instruction that saturates results sets the SAT bit in the Control Status Register (CSR) if saturation occurs. [†]	
	Execute 4	E4	Load instructions: data is brought to CPU boundary [†]	
	Execute 5	E5	Load instructions: data is loaded into register [†]	Loads

[†]This assumes that the conditions for the instructions are evaluated as true. If the condition is evaluated as false, the instruction will not write any results or have any pipeline operation after E1.

5 Referring again to Figure 4 and Figure 1, the instruction execution pipeline of processor 10 involves a number of discrete stages, generally demarcated by temporary latches or registers to pass the results of one stage to the next. Instruction pipeline phases PG, PS, PW, and PR all involve instruction fetching and are embodied in program fetch circuit 10 in association with program memory subsystem 23. Pipeline phases DP and DC involve instruction decoding; phase DP is embodied in dispatch circuitry 10b,

10

while pipeline phase DC is embodied in decode circuitry 10c. The execution phases E1-E5 are embodied in stages embodied within each functional unit L, S, M and D. For example, the D units embody all five execute stage in association with memory subsystem 22. Other of the functional units do not embody all five execution phase, but only what is required for the instruction types that are executed by a particular functional unit.

The execution of instructions can be defined in terms of delay slots, as shown in Table 7. A delay slot is a CPU cycle that occurs after the first execution phase (E1) of an instruction in which results from the instruction are not available. For example, a multiply instruction has 1 delay slot, this means that there is 1 CPU cycle before another instruction can use the results from the multiply instruction.

Table 7 Delay Slot Summary

Instruction Type	Delay Slots	Execute Stages Used
Branch (The cycle when the target enters E1)	5	E1-branch target E1
Load (LD) (Incoming Data)	4	E1 - E5
Load (LD) (Address Modification)	0	E1
Multiply	1	E1 - E2
Single-cycle	0	E1
Store	0	E1
NOP (no execution pipeline operation)	-	-
STP (no CPU internal results written)	-	-

Single cycle instructions execute during the E1 phase of the pipeline. The operand is read, operation is performed and the results are written to a register all during E1. These instructions have no delay slots.

Multiply instructions complete their operations during the E2 phase of the pipeline. In the E1 phase, the operand is read and the multiply begins. In the E2 phase, the multiply finishes, and the result is written to the destination (*dst*) register. Multiply instructions have 1 delay slot.

Load instructions have two results: data loaded from memory and address pointer modification.

Data loads complete their operations during the E5 phase of the pipeline. In the E1 phase, the address of the data is computed. In the E2 phase, the data address is sent to data memory. In the E3 phase, a memory read is performed. In the E4 stage, the data is received at the CPU core boundary. Finally, in the E5 phase, the data is loaded into a register. Because data is not written to the register until E5, these instructions have 4 delay slots. Because pointer results are written to the register in E1, there are no delay slots associated with the address modification.

Store instructions complete their operations during the E3 phase of the pipeline. In the E1 phase, the address of the data is computed. In the E2 phase, the data address is sent to data memory. In the E3 phase, a memory write is performed. The address modification is performed in the E1 stage of the pipeline. Even though stores finish their execution in the E3 phase of the pipeline, they have no delay slots and follow the following rules (i = cycle):

1) When a load is executed before a store, the old value is loaded and the new value is stored.

2) When a store is executed before a load, the new value is stored and the new value is loaded.

3) When the instructions are in are in parallel, the old value is loaded and the new value is stored.

Multiply 16 lsb X 32-bit, shift and round (MPYLIR), Multiply 16 msb X 32-bit, shift and round (MPYHIR) Instructions

An aspect of the present embodiment is that the DSP of Figure 1 includes an extensive set of packed data instructions that provide features of single instruction, multiple data (SIMD) operation. By so doing, performance of the processor is improved. Other instructions are provided to operate on packed fields. One such instruction is a Multiply 16 lsb X 32-bit, shift and round (MPYLIR) instruction. Another instruction included in the present

embodiment is a Multiply 16 msb X 32-bit, shift and round (MPYHIR) instruction.

Figure 5 illustrates an instruction syntax for an MPYLIR instruction. This same syntax is used for an MPYHIR. In this embodiment, an MPY(H/L)IR instruction can be executed in either .M functional unit 14a or 14b as indicated by unit select bit field 500. The instruction includes a first source operand field (src1) 501 and a second source operand field (src2) 502 that each select a register from associated register file 20a or 20b to access a source operand which is a 32-bit data value. The MPYHIR instruction performs a 16-bit by 32-bit multiply. The upper half of *src1* is used as a 16-bit signed input. The value in *src2* is treated as a 32-bit signed value. The product is then rounded to a 32-bit result by adding the value 2^{14} and then this sum is right shifted by 15. The lower 32-bits of the result are written into a destination register specified by a destination field (dst) 504.

Likewise, the MPYLIR instruction performs a 16-bit by 32-bit multiply. The lower half of *src1* is used as a 16-bit signed input. The value in *src2* is treated as a 32-bit signed value. The product is then rounded to a 32-bit result by adding the value 2^{14} and then this sum right shifted by 15. The lower 32-bits of the result are written into *dst*.

A complementary instruction, a MPYIHR pseudo-operation performs a 16-bit by 32-bit multiply. The upper half of *src1* is used as a 16-bit signed input. The value in *src2* is treated as a 32-bit signed value. The product is then rounded to a 32-bit result by adding the value 2^{14} and then this sum is right shifted by 15. The lower 32-bits of the result are written into *dst*. An assembler uses a MPYHIR *src1*, *src2*, *dst* to perform this operation.

Another complimentary instruction, a MPYILR pseudo-operation performs a 16-bit by 32-bit multiply. The lower half of *src1* is used as a 16-bit signed input. The value in *src2* is treated as a 32-bit signed value. The product is then rounded to a 32-bit result by adding the value 2^{14} and then

this sum right shifted by 15. The lower 32-bits of the result are written into *dst*. The assembler uses a MPYLIR *src1*, *src2*, *dst* instruction to perform this operation.

Referring still to Figure 5, field 510 defines a class of instruction formats, while opcode field 512 specifies that a particular instruction of this class is an MPYLIR or MPYHIR instruction. Crossover control field 514 specifies which register file 20a or 20b will be accessed for a source operand, as discussed previously. Parallel bit 516 indicates if this instruction is to be executed in parallel with an adjacent instruction in a fetch packet, as discussed previously.

As with all of the instructions executed by the DSP of Figure 1, the MPYLIR/L instructions are conditional based on a predicate register selected by condition register field (creg) 506 and zero indicator bit 508, as discussed previously.

Table 8 defines the operation of the MPYHIR instruction, while Table 9 defines the operation of the MPYLIR instruction using pseudo code. Just as with other conditionally executed instructions, if the predicate condition tests false, MPY(H/L)IR instruction does not complete execution and the write of the *dst* register is inhibited.

Table 8 - Execution of MPYHIR Instruction

```

if (cond) {
    lsb32(((msb16(src1) x (src2)) + 0x4000) >> 15) → dst
}
else nop

```

Table 9 – Execution of MPYLIR Instruction

<pre> if (cond) { lsb32(((lsb16(src1) x (src2)) + 0x4000) >> 15) → dst } else nop </pre>
--

Figure 6A is a flow chart illustrating operation of the MPYHIR instructions. The MPYHIR instruction performs a multiply operation on packed 16-bit data from a first selected source operand (src1) 600 and a 32-bit data value contained in a second selected source operand (src2) 601. A data value in source operand 600 is treated as packed, signed 16-bit data, located in two distinct fields 600(0), 600(1). The product is then rounded and then right-shifted by 15 to produce a 32-bit result that is written to a selected destination register 650. The intermediate results are kept at full precision internally, so that no overflow conditions exist.

In step 610, a first pair of elements are multiplied together to form a first product. The most significant 16-bit value 600(1) of the first source operand and the most significant 16-bit value 601(1) of the second source operand are multiplied together to form a 32-bit first product. In step 611, a second pair of elements are multiplied together to form a second product. The most significant 16-bit value 600(1) of the first source operand and the least significant 16-bit value 601(0) of the second source operand are multiplied together to form a 32-bit second product. The two products are formed simultaneously by a pair of multiplier circuits in the M1 functional unit during the E1 execute phase.

In step 620, the first product is combined with the second product to form a 47-bit combined product. During this step, the first product is first shifted left by 16 bits since it corresponds to the most significant portion of src2. Both products are treated as signed values.

In step 630, the combined product is rounded by adding a rounding value to form an intermediate value. A rounding value of 0x4000 (2^{14}) is added to the combined product to form the intermediate value. This has the effect of rounding the signed 47-bit combined product at bit position 15. The intermediate value is treated as a signed integer value.

In step 640, the intermediate result is right shifted by fifteen bits and sign extended to form a 32-bit final result. Thus, the shifting truncates a selected number of least significant bits of the intermediate result such that the final result is shorter than the combined product, although it is sign extended to 32-bits for storage in a 32 bit register. The final result is then written to a register 650 in register file A specified by a "dst" field in the multiplication instruction during an E4 execution phase of the instruction execution pipeline of the processor, resulting in three delay slots for execution of this instruction.

In this embodiment, rounding at bit 15 of the 47-bit combined product with a rounding value of 0x4000 (2^{14}) and right shifting fifteen bits is performed in order to reduce processing time required for applications such as a high precision fast Fourier Transform, (FFT). The inventor of the present invention discovered that source code written for applications such as FFT in the known C programming language often contains a sequence of instructions which formed two 16 x 32-bit products which are added together as 48 bit quantities to maintain precision and then right shifted to form a 32-bit result. Advantageously, by using the rounding multiply instructions of the present invention, the prior sequence above can be directly replaced with a sequence of MPYHIR, MPYLIR, and ADD (32-bit) to reduce instruction count and improve processing performance. There is a difference of one-half bit at the most between results obtained by both sequences.

Figure 6C is a flow chart illustrating an alternative embodiment of the operation of the MPYLIR instruction. In another embodiment, the least

significant product from step 611 is rounded by adding 0x4000 in step 660 and then shifting right by 15 bits in step 662 to form a truncated least significant product. In step 664, the most significant product from step 610 is shifted left by just one bit, then the most significant product and the truncated least significant product, such as: $((a_hi * b_ho) \ll 1) + ((a_hi * b_lo + 0x4000) \gg 15)$.

Figure 6B is a flow chart illustrating operation of the MPYLIR instruction. The MPYHIR instruction performs a multiply operation on packed 16-bit data from a first selected source operand (src1) 600 and a 32-bit data value contained in a second selected source operand (src2) 601. A data value in source operand 600 is treated as packed, signed 16-bit data, located in two distinct fields 600(0), 600(1). The product is then rounded and then right-shifted by 15 to produce a 32-bit result. The intermediate results are kept at full precision internally, so that no overflow conditions exist.

In step 610, a first pair of elements are multiplied together to form a first product. The least significant 16-bit value 600(0) of the first source operand and the most significant 16-bit value 601(1) of the second source operand are multiplied together to form a 32-bit first product. In step 611, a second pair of elements are multiplied together to form a second product. The least significant 16-bit value 600(1) of the first source operand and the least significant 16-bit value 601(0) of the second source operand are multiplied together to form a 32-bit second product. The two products are formed simultaneously by a pair of multiplier circuits in the M1 functional unit during the E1 execute phase.

The remaining steps 620, 630 and 64 are identical to Figure 6A.

Figure 7A is a top level block diagram of .M unit 14a, which is optimized to handle multiplication, although hardware is available for a limited set of non-multiply operations. In this embodiment, multiplier units M1, M2 are each similar and will be described in more detail with reference

to Figures 7B-7D. A rounding multiply instruction MPY(H/L)IR can be executed on either one of the multiply units M1, M2 during any execution cycle of the instruction execution pipeline, unless a resource conflict limits inclusion of a rounding multiply instruction within a given execution packet.

5 The .M unit has three major functional units: Galois multiply unit 700a-c, multiply unit 710 and other non-multiply functional circuitry in block 720. Galois multiplier 700a-c and multiplier 710 require three additional cycles to complete the multiply operations, so multiply instructions are categorized as having three delay slots. Pipeline registers 730-733 hold
10 partial results between each pipeline execution phase. In general, multiply unit 710 can perform the following operations on a pair of multipliers 711a,b: two 16x16 multiplies or four 8x8 multiplies with all combination of signed or unsigned numbers, Q-shifting and P-shifting of multiply results, rounding for multiply instructions, controlling the carry chain by breaking/joining the
15 carry chain at 16-bit block boundaries, and saturation multiplication where the final result is shifted left by 1 or returns 0x7FFFFFFF if an overflow occurs. Galois multiply unit 700 performs Galois multiply in parallel with M multiply unit 710. The lower 32 bits (bits 31:0) of a result are selected by multiplexer 734 and are stored in the even register of a register pair. The
20 upper 32 bits (bits 63:33) of the result are selected by multiplexer 735 and are stored in the odd register of the register pair. A more detailed description of configurable multiply circuitry is provided in co-assigned U.S. Patent application S.N. _____ (TI-26010) entitled *Data Processor With Flexible Multiply Unit* and is incorporated herein by reference. Details of the Galois
25 multiply unit are provided in co-assigned U.S. Patent application S.N. _____ (TI-26013) to David Hoyle entitled *Galois Field Multiply* and is incorporated herein by reference.

Advantageously, in this embodiment, two rounding multiply instructions can be simultaneously executed during the same execution cycles

on both M1 and M2, subject to resource constraints. Other embodiments of the invention may provide different compliments of multiply units, such as only one multiply unit, or three or more, for example. Therefore, in the following description of the rounding multiply instruction it is to be understood that even though the operation will be described with reference to the M1 functional unit, operation on the M2 functional unit is similar.

Figure 7B is a block diagram of an the paired multipliers that can be used in a digital system to embody the present invention. The M unit includes a pair of 16 by 16 multipliers mpy0, mpy1 and auxiliary hardware to enable a large number of multiply functions. The M unit receives two register inputs (src1 and src2) and generates a 64 bit output to an even/odd pair of registers. Each multiplier receives two 16 bit inputs. These may be independently selected as the upper/lower 16 bits of the 32 bit data word recalled from the src1 and src2 operand registers via selectors 500, 502. Each multiplier uses part of src1 and part of src2. The part used (upper/lower 16 bits) is independently selectable via op code. Each multiplier has a size input enabling selection of a single 16 by 16 bit multiply or a pair of 8 by 8 bit multiplies.

Shifters 510, 512 have fixed shift functions coded in the op code of certain instructions. These are selected from a limited set of shifts. Shifter 510 corresponding to mpy0 may select a 0 bit shift or a 16 bit left shift. Shifter 512 corresponding to mpy1 may select 0 bit shift, a 16 bit right shift, or a 32 bit right shift. The shift operation may generally be applied to the separate upper/lower 16 bit parts of the product of each multiplier. When a rounding 16 x 32-bit instruction is executed, shifter 510 is set to provide a 0 bit shift and shifter 512 is set to provide a 16-bit right shift to properly align the two partial products.

The output of these shifters is supplied to a 64 bit adder/subtractor 520. The output of shifter 510, being a least significant product, is generally

supplied to the lower portion of the 64 bit adder/subtractor bits (47:0) depending upon the selected shift. Similarly, the output of shifter 512, being a most significant product, is generally supplied to the upper portion of the 64 bit adder bits (63:0) depending upon the selected shift. In the case of
5 executing a rounding 16 x 32-bit instruction, the most significant partial product is supplied to a 32-bit mid portion of the adder input port in response to the selected shift values. Thus, a 47-bit combined product is formed by adder 520 during execution of a rounding 16 x 32-bit instruction.

Mid-point rounding signal MRND is connected to adder/subtractor 520
10 as an additional input to bit 14 and is asserted when a rounding 16 x 32-bit instruction is executed. This has the effect of adding a mid-position rounding value of 0x4000 to the combined product. This bit input is referred to as a "ram" bit such that the value of 0x4000 is "rammed" into the combined product. Thus, an intermediate result for a 16 x 32-bit instruction is formed
15 at the output of adder 520 as a 47-bit sign extended integer value with mid-position rounding.

Shifter 540 provides shift value of 0, 15, and 16 bits. During execution of a rounding 16 x 32-bit instruction, shifter 540 is selected to provide a right shift of fifteen bits.

20 In another embodiment, a rounding signal is substituted for a carry-in bit.

Other System Examples

Several example systems which can benefit from aspects of the present
25 invention are described in U.S. Patent 5,072,418, which was incorporated by reference herein, particularly with reference to Figures 2-18 of U.S. Patent 5,072,418. A microprocessor incorporating an aspect of the present invention to improve performance or reduce cost can be used to further improve the systems described in U.S. Patent 5,072,418. Such systems include, but are

not limited to, industrial process controls, automotive vehicle systems, motor controls, robotic control systems, satellite telecommunication systems, echo canceling systems, modems, video imaging systems, speech recognition systems, vocoder-modem systems with encryption, and such.

Figure 8 illustrates an exemplary implementation of an example of an integrated circuit 40 that includes digital system 1 in a mobile telecommunications device, such as a wireless telephone with integrated keyboard 12 and display 14. As shown in Figure 7, digital system 1 with processor 10 is connected to the keyboard 12, where appropriate via a keyboard adapter (not shown), to the display 14, where appropriate via a display adapter (not shown) and to radio frequency (RF) circuitry 16. The RF circuitry 16 is connected to an aerial 18. Advantageously, by providing a set of rounding 16 x 32-bit instructions, complex signal processing algorithms, such as high precision FFTs, can be written in a more efficient manner to satisfy the demand for enhanced wireless telephony functionality.

Fabrication

Fabrication of digital system 1 involves multiple steps of implanting various amounts of impurities into a semiconductor substrate and diffusing the impurities to selected depths within the substrate to form transistor devices. Masks are formed to control the placement of the impurities. Multiple layers of conductive material and insulative material are deposited and etched to interconnect the various devices. These steps are performed in a clean room environment.

A significant portion of the cost of producing the data processing device involves testing. While in wafer form, individual devices are biased to an operational state and probe tested for basic operational functionality. The wafer is then separated into individual dice which may be sold as bare die or packaged. After packaging, finished parts are biased into an operational state

and tested for operational functionality. An integrated circuit that includes any of the above embodiments includes a plurality of contacts for surface mounting. However, the integrated circuit could include other configurations, for example a plurality of pins on a lower surface of the circuit for mounting in a zero insertion force socket, or indeed any other suitable configuration.

Digital system 1 contains hardware extensions for advanced debugging features. These assist in the development of an application system. Since these capabilities are part of the CPU core itself, they are available utilizing only the JTAG interface with extended operating mode extensions. They provide simple, inexpensive, and speed independent access to the core for sophisticated debugging and economical system development, without requiring the costly cabling and access to processor pins required by traditional emulator systems or intruding on system resources.

Thus, a functional unit in a digital system is provided with a set of rounding 16 x 32-bit instruction. Rounding is performed by adding a rounding value to form an intermediate result, and then shifting the intermediate result right. A combined result is rounded to a fixed length shorter than the combined product.

As used herein, the terms "applied," "connected," and "connection" mean electrically connected, including where additional elements may be in the electrical connection path. "Associated" means a controlling relationship, such as a memory resource that is controlled by an associated port. The terms assert, assertion, de-assert, de-assertion, negate and negation are used to avoid confusion when dealing with a mixture of active high and active low signals. Assert and assertion are used to indicate that a signal is rendered active, or logically true. De-assert, de-assertion, negate, and negation are used to indicate that a signal is rendered inactive, or logically false.

While the invention has been described with reference to illustrative embodiments, this description is not intended to be construed in a limiting

sense. Various other embodiments of the invention will be apparent to persons skilled in the art upon reference to this description. For example, more than two multiply circuits can be conjoined to provide even greater flexibility than a pair of multipliers, such that a matching number of pairs of
5 input values are packed into the source operands. Other boundaries can be defined, such as a plurality of twelve bit multipliers, for example. A single M unit can be embodied in a digital system, or more the two M units can be embodied in a single digital system, for example.

Within an M unit, various combinations of fixed and/or variable
10 shifters can be provided. Other mid-point rounding locations may be selected such that the rounding value is 2^{n+1} and the intermediate result is shifted $n+1$. For example a rounding value of 2^{11} with a twelve bit right shift. Alternatively, instead of performing a right shift of $n+1$, a left shift can be performed to shift the final result to a more significant portion of a 64-bit
15 output register, for example, to form a final result such that the n lsbs of the intermediate result stored in a destination register are truncated.

Other embodiments may report overflow as a status bit, for example, during product combination or rounding; software can then choose to ignore the overflow indications.

20 Another embodiment may treat both values of each pair of elements as signed numbers, or may treat both values of each pair of elements as unsigned numbers, for example.

In an embodiment of the invention, one instruction is provided which selects a high half word from two packed fields, and another instruction is
25 provided that selects a low half word from two packed fields. In another embodiment, the number of fields may be different than two. In another embodiment, a control register or parameter selects the field.

In another embodiment, a prior final result is retrieved from a destination location and is combined with a current final result and the accumulated final result is stored at the destination location.

5 It is therefore contemplated that the appended claims will cover any such modifications of the embodiments as fall within the true scope and spirit of the invention.

What is claimed is:

1. A method of performing a product operation with rounding in a microprocessor in response to a single rounding multiplication instruction,
5 the method comprising the steps of:

fetching a first pair of elements and a second pair of elements;

forming a most significant product of a first element of the first pair of elements and a most significant element of the second pair of elements and a least significant product of the first element of the first pair of elements and a least significant element of the second pair of elements;
10

combining the most significant product with the least significant product to form a combined product;

rounding the combined product to form an intermediate result; and

shifting the intermediate result a selected amount to form a final result.
15

2. The method of Claim 1, wherein the step of shifting truncates a selected number of least significant bits of the intermediate result.

3. The method of Claim 2, wherein the step of rounding adds a rounding value to the combined product to form the intermediate result, and wherein the step of shifting shifts the intermediate result right by a selected shift amount.
20

4. The method of Claim 3, wherein the rounding value is 2^{*n} and the selected shift amount is $n+1$.
25

5. The method of Claim 4, wherein n has a fixed value of fourteen.

6. The method of Claim 1, wherein the first element of the first pair of elements is a most significant element of the first pair of elements.

7. The method of Claim 1, wherein the step of combining comprises shifting the most significant product left by a width of the least significant element of the second pair of elements prior to adding the most significant product to the least significant product.

8. A method of performing a product operation with rounding in a microprocessor in response to a single rounding multiplication instruction, the method comprising the steps of:

fetching a first pair of elements and a second pair of elements;

forming a most significant product of a first element of the first pair of elements and a most significant element of the second pair of elements and a least significant product of the first element of the first pair of elements and a least significant element of the second pair of elements;

rounding the least significant product to form a rounded least significant product;

shifting the rounded least significant result a selected amount to form a truncated least significant result; and

combining the most significant product with the truncated least significant product to form a final result.

9. A digital system having a microprocessor operable to execute a rounding multiplication instruction, wherein the microprocessor comprises:

storage circuitry for holding pairs of elements;

a multiply circuit connected to receive a first number of pairs of elements from the storage circuitry in a first execution phase of the

microprocessor responsive to the multiplication instruction, the multiply circuit comprising a plurality of multipliers;

an arithmetic circuit connected to receive a most significant product and a least significant product from the plurality of multipliers, the arithmetic circuit having a provision for mid-position rounding responsive to the rounding multiplication instruction; and

a shifter connected to receive an output of the arithmetic circuit, the shifter operable to shift a selected amount in response to the rounding multiplication instructions.

10. The digital system of Claim 9, wherein the arithmetic circuit has a additional input connected to a mid-position, wherein the additional input is asserted in response to the rounding multiplication instruction.

11. The digital system according to Claim 9 being a cellular telephone, further comprising:

an integrated keyboard connected to the processor via a keyboard adapter;

a display, connected to the processor via a display adapter;

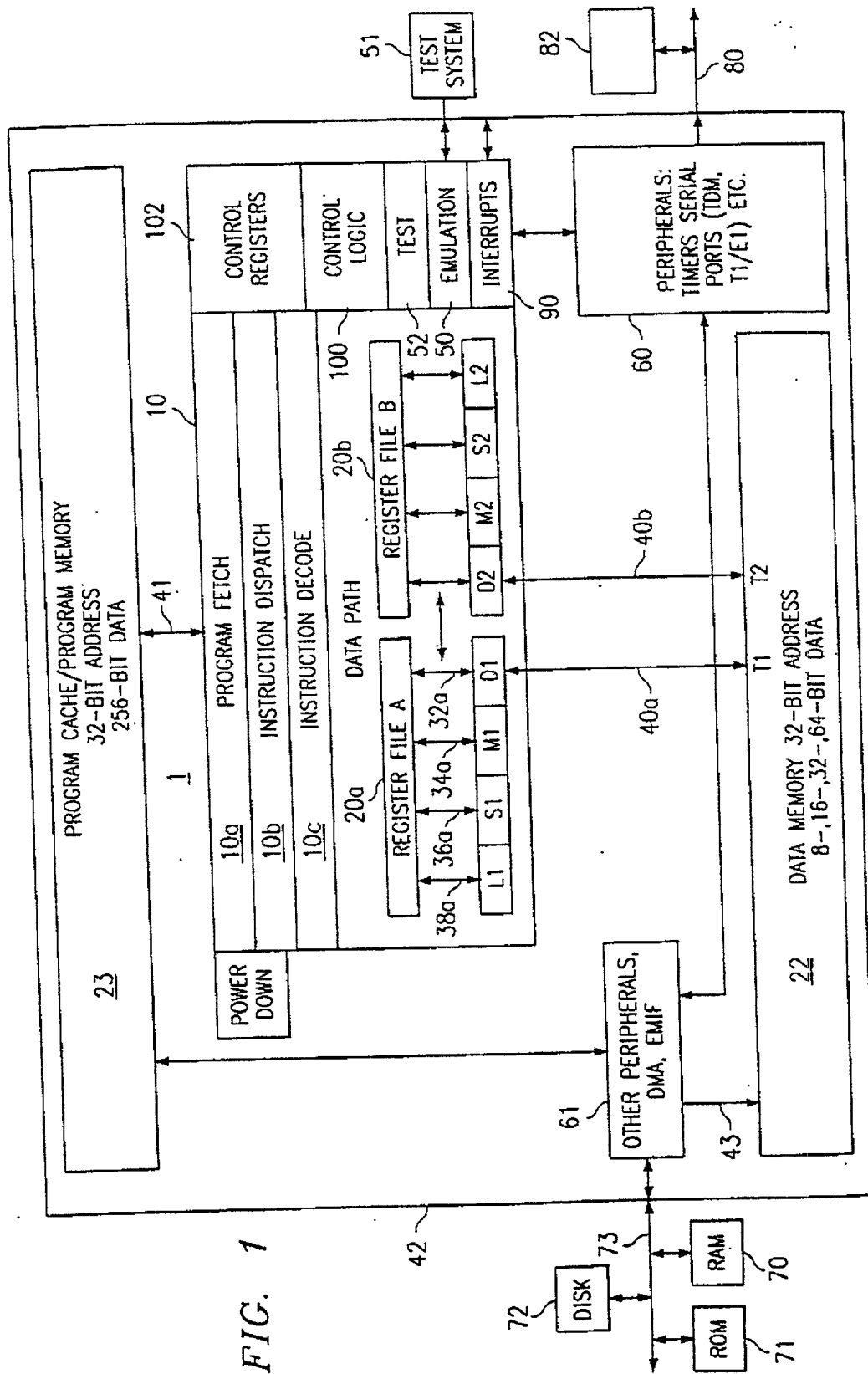
radio frequency (RF) circuitry connected to the processor; and

an aerial connected to the RF circuitry.

Abstract

5 A functional unit in a digital system is provided with a rounding
Multiplication instruction, wherein a most significant product of first pair of
elements is combined with a least significant product of a second pair of
elements, the combined product is rounded, and the final result is stored in a
destination. Rounding is performed by adding a rounding value to form an
intermediate result, and then shifting the intermediate result right. A
10 combined result is rounded to a fixed length shorter than the combined
product.

1/12



~~TI 30559~~
~~2 of 8~~

2/12

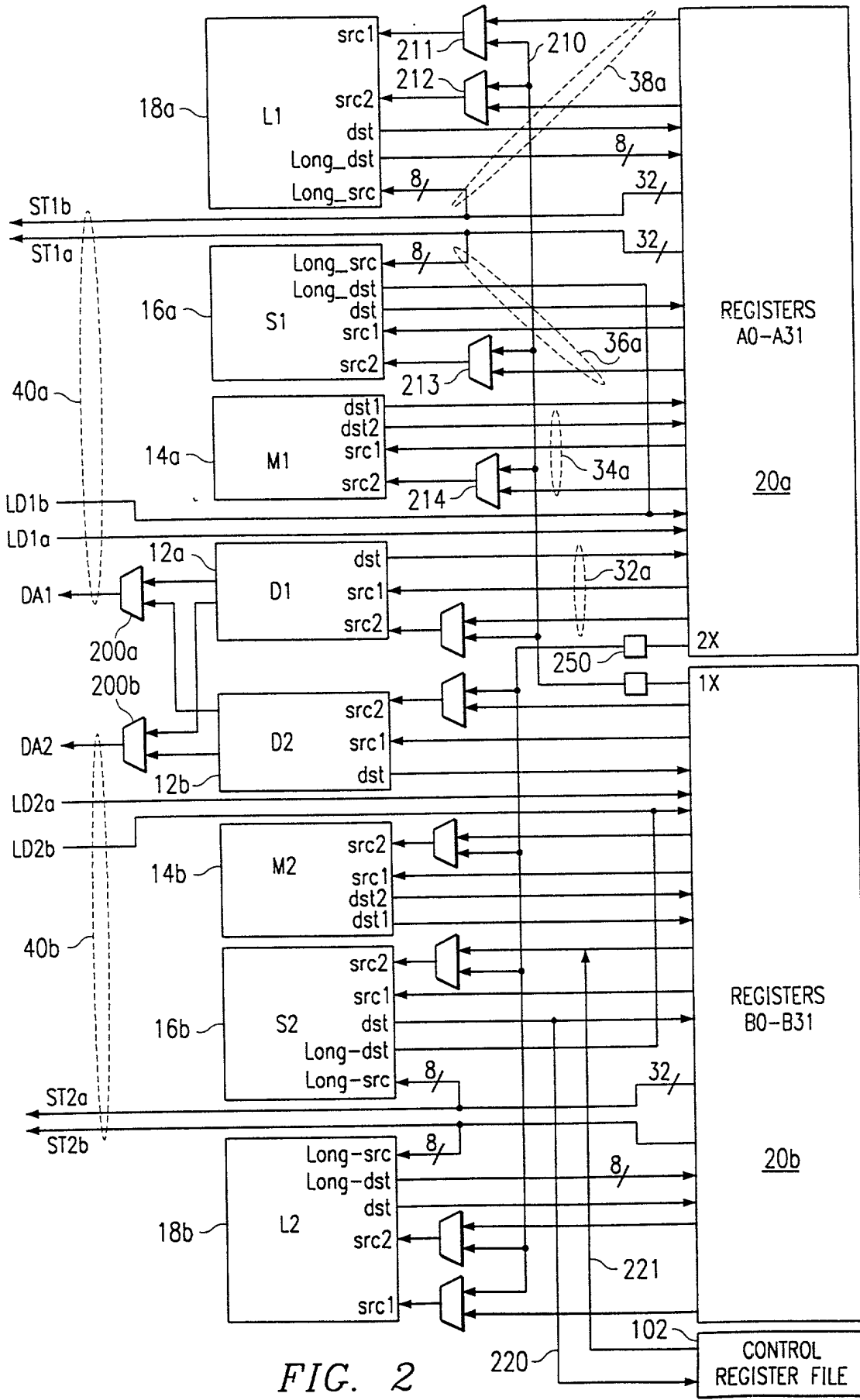


FIG. 2

OPERATIONS ON THE .L UNIT

31	29	28	27	23	22	18	17	13	12	11	5	4	3	2	1	0
CREG	Z		DST		SCR2		SRC1/CST	X		OP		1	1	0	S	P
3			5			5			7							

FIG. 3A

OPERATIONS ON THE .M UNIT

OPERATIONS ON THE .M UNIT																		
31	29	28	27	23	22	18	17	13	12	11	7	6	5	4	3	2	1	0
CREG	Z		DST		SCR2		SRC1/CST	X		OP		0	0	0	0	0	S	P
3			5			5			5									

FIG. 3B

OPERATIONS ON THE .D UNIT

OPERATIONS ON THE .D UNIT																	
31	29	28	27	23	22	18	17	13	12	7	6	5	4	3	2	1	0
CREG	Z		DST		SCR2		SRC1/CST		OP		1	0	0	0	0	S	P
3			5			5			6								

FIG. 3C

LOAD/STORE WITH 15-BIT OFFSET (ON THE .D UNIT)

LOAD/STORE WITH 15-BIT OFFSET (ON THE .D UNIT)															
31	29	28	27	23	22	8 7 6 4 3 2 1 0									
CREG		Z	DST/SRC		UCST15										
						Y		LD/ST		1	1	S	P		
3			5			15			3						

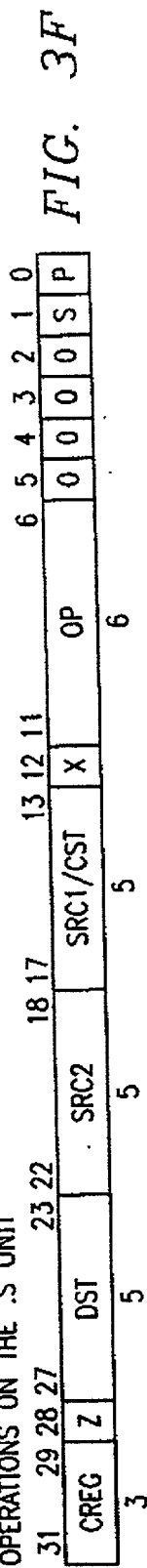
FIG. 3D

LOAD/STORE 'BASER' + 'OFFSETR/CST' ON THE .D UNIT

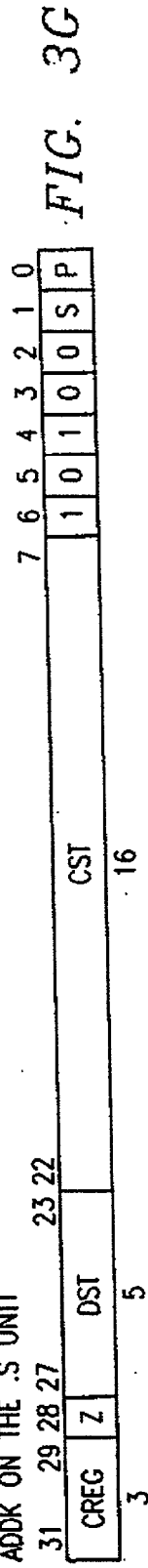
LOAD/STORE 'BASER' + 'OFFSELR/CST' ON THE .D UNIT																		
31	29	28	27	23	22	18	17	13	12	9	8	7	6	4	3	2	1	0
CREG	Z		DST/SRC		BASE R		OFFSET R/UCST5		MODE		R	Y	LD/ST	0	1	S	P	
3			5			5			4			3						

FIG. 3E

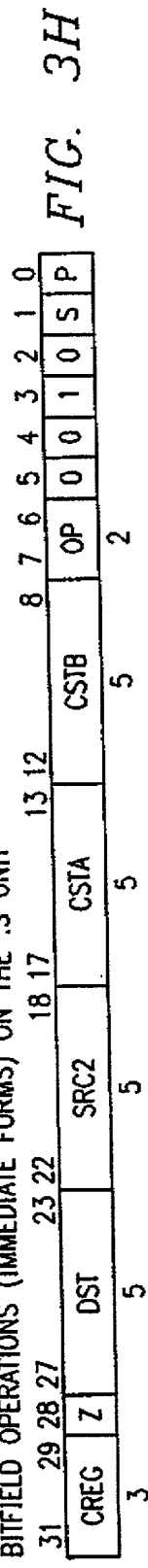
OPERATIONS ON THE .S UNIT



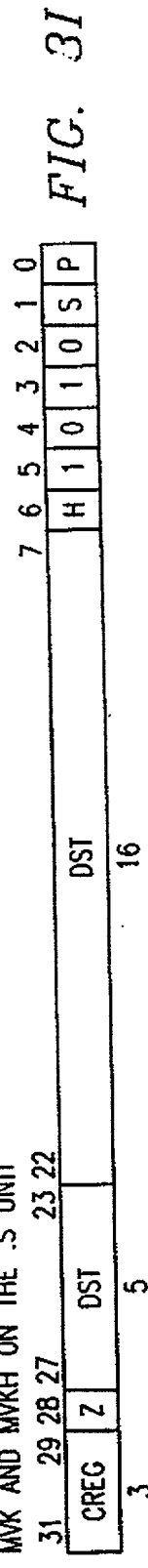
ADDK ON THE .S UNIT



BITFIELD OPERATIONS (IMMEDIATE FORMS) ON THE .S UNIT



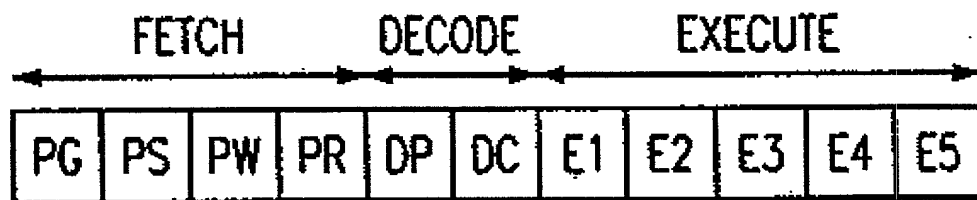
MVK AND MVKH ON THE .S UNIT



BCOND DISP ON THE .S UNIT

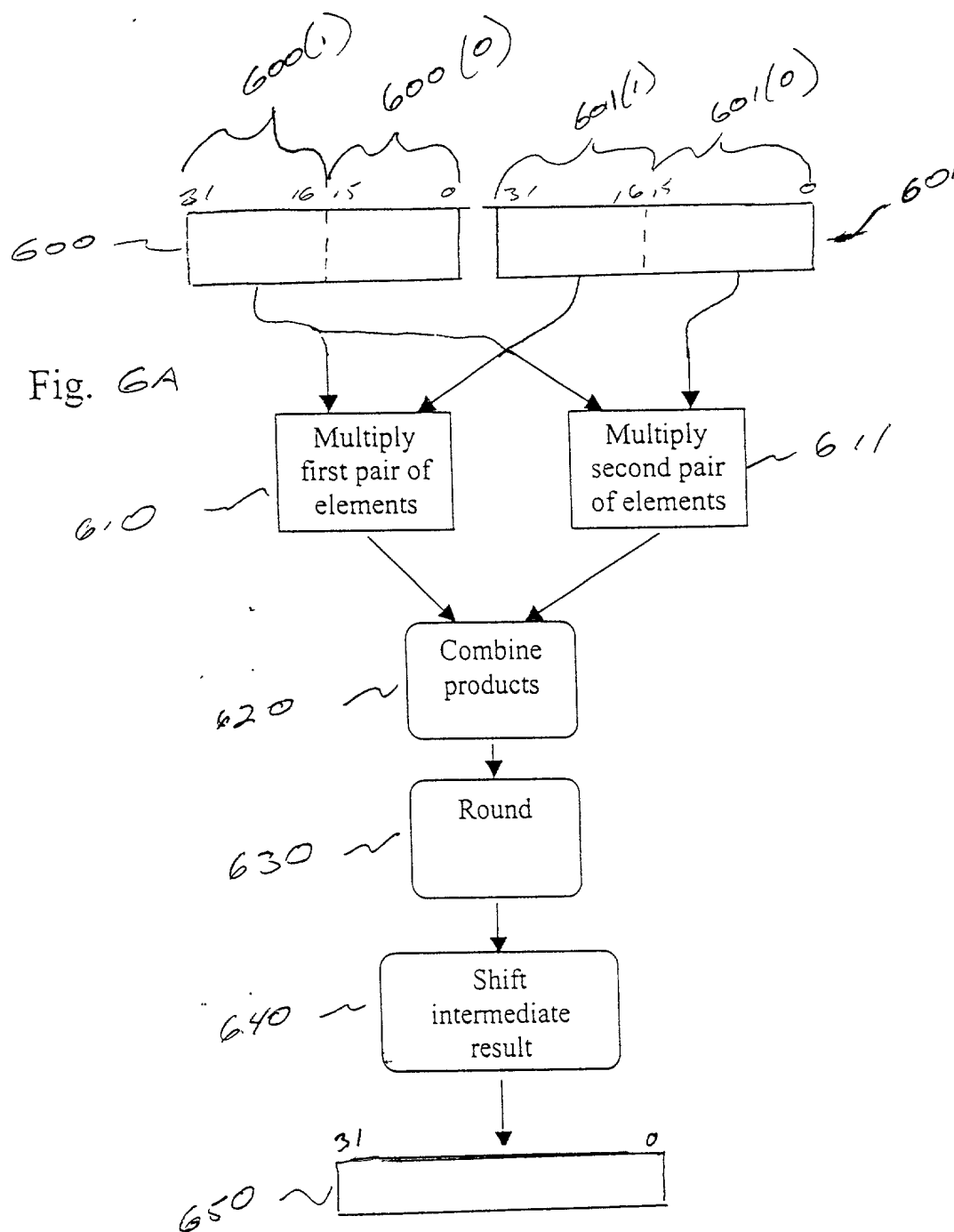


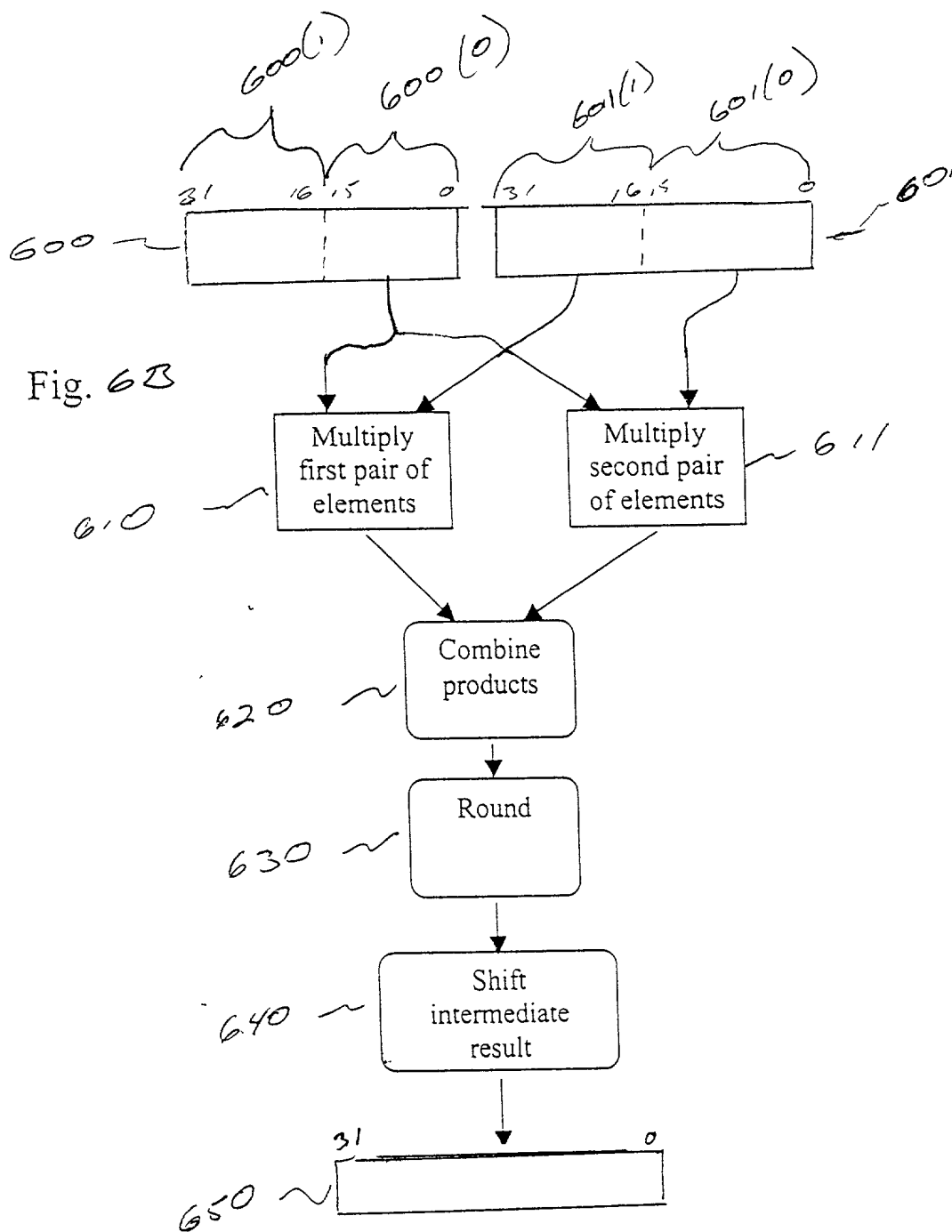
5/12

*FIG. 4*

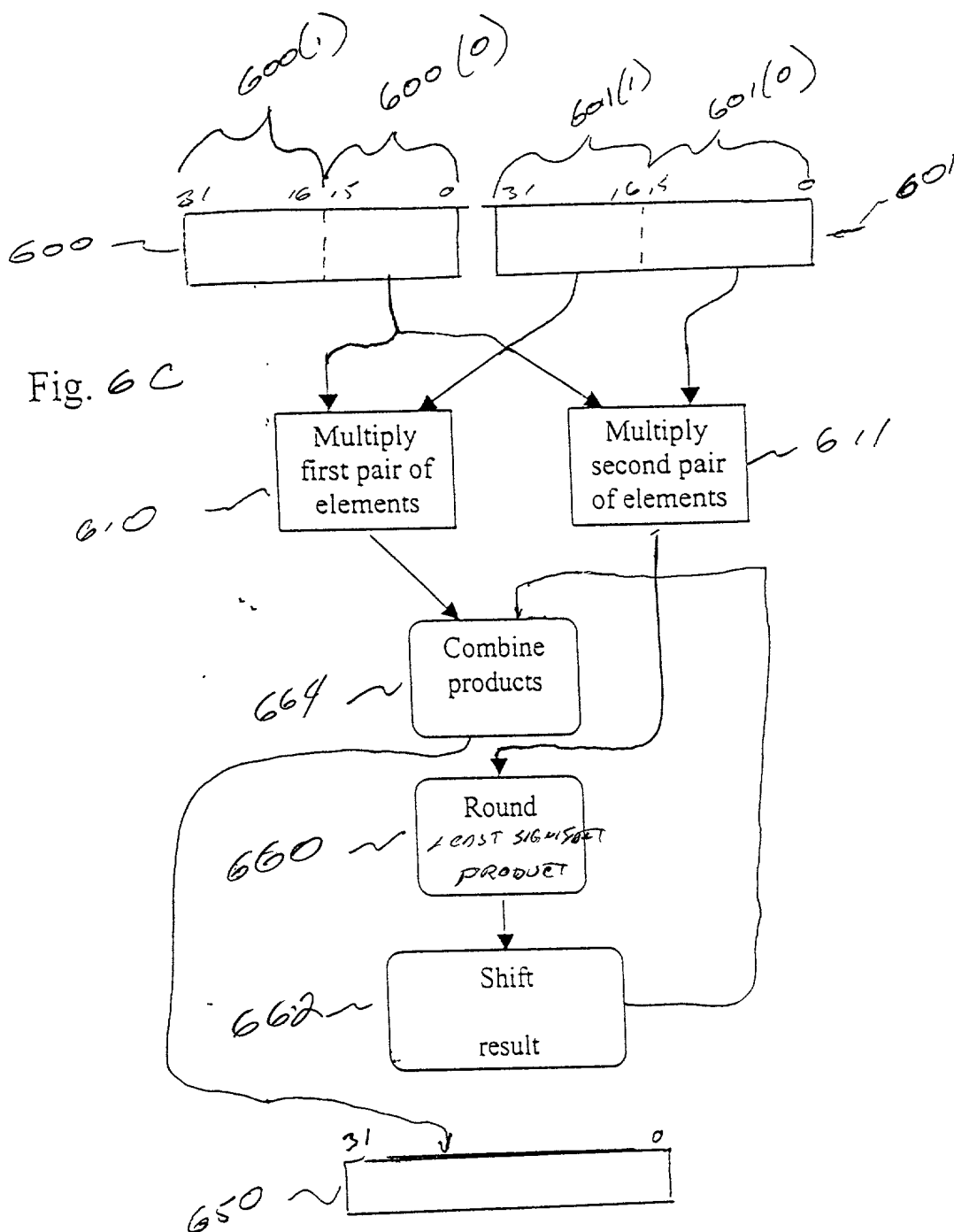


7/12

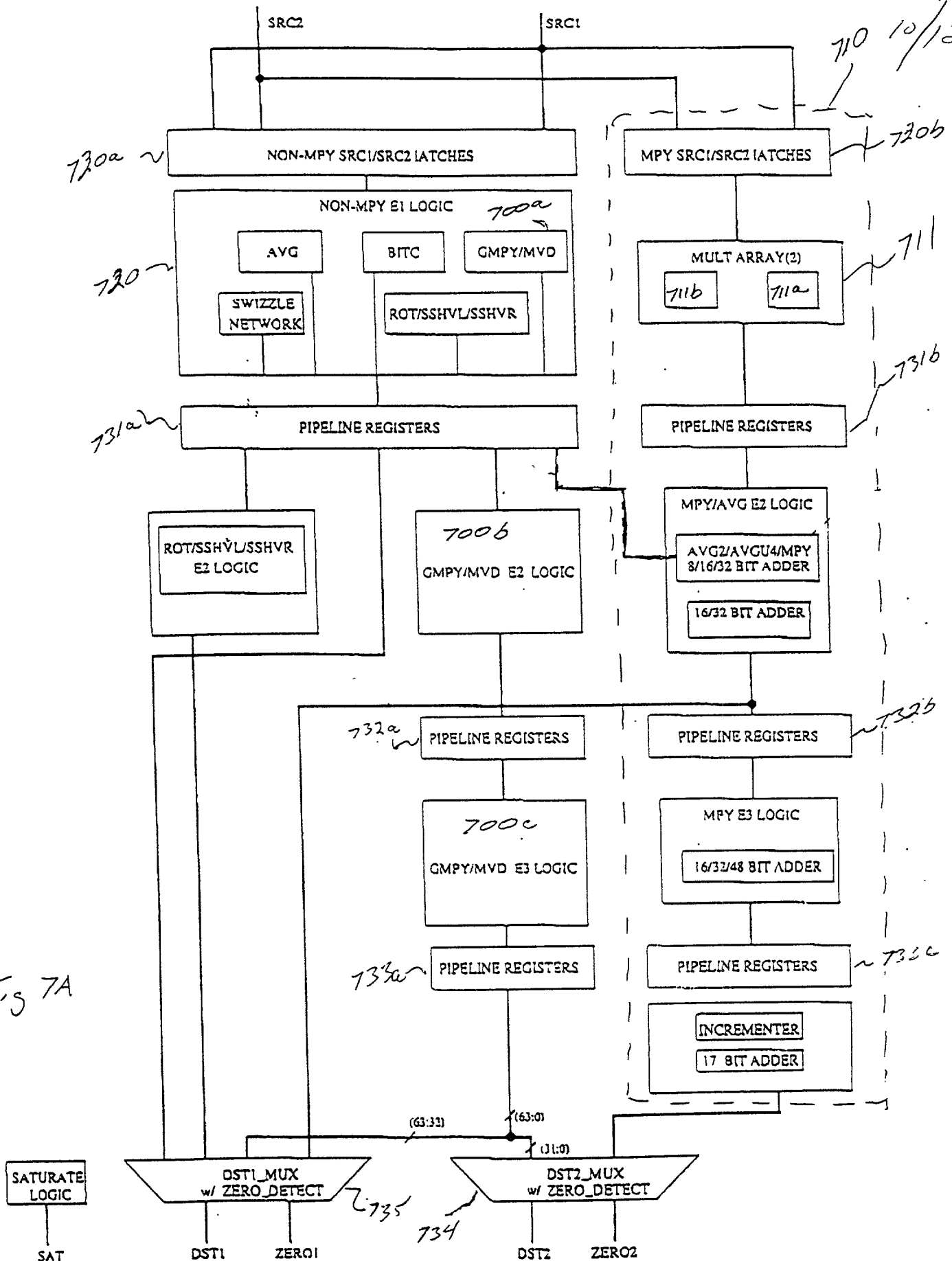




9/12



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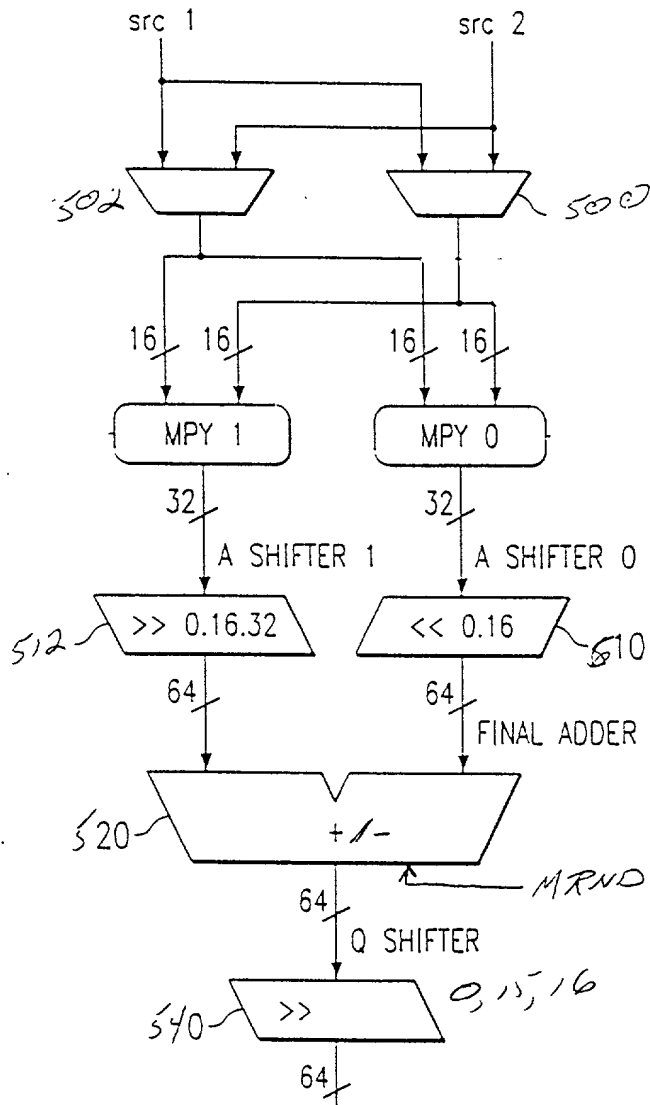


FIG. 7B

12/12

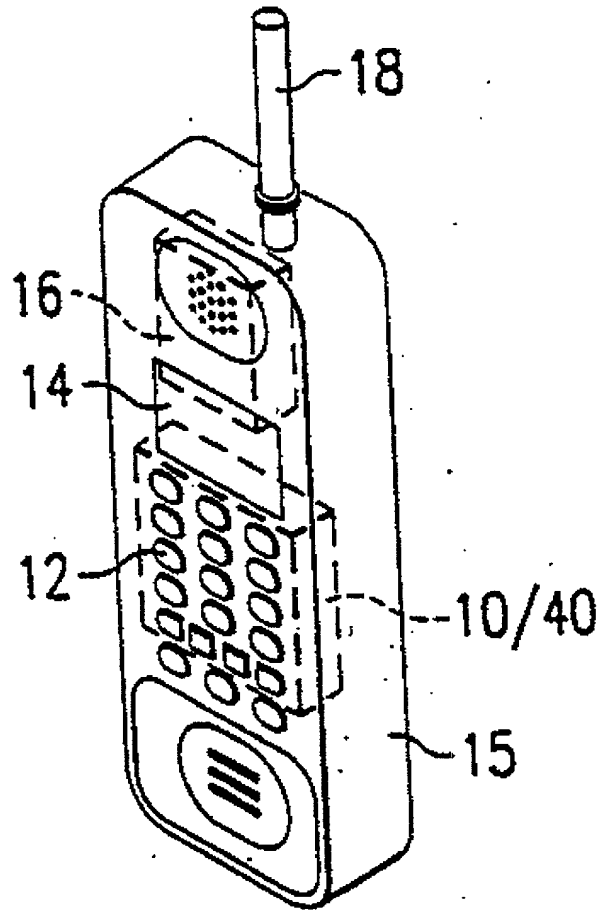


Fig 8

PAGE 1 OF 1

**APPLICATION FOR UNITED STATES PATENT
DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, which is described in the attached specification [of **Application Serial No. XX, filed XX**]; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56;

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

TITLE OF INVENTION:		
Microprocessor With Rounding Multiply Instructions		
POWER OF ATTORNEY: I HEREBY APPOINT THE FOLLOWING ATTORNEYS TO PROSECUTE THIS APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH		
Practitioners at Customer Number: 23494		
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NAME OF INVENTOR: (1)	NAME OF INVENTOR: (2)	NAME OF INVENTOR: (3)
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COUNTRY OF CITIZENSHIP: UK	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:
SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:
DATE:	DATE:	DATE: